

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
YUN-TAI SHIH	10/18/2011
KUAN-MING PAN	10/25/2011
JENG-HAO LIN	10/18/2011
I-SHI WANG	10/18/2011
JUI-MU CHO	10/26/2011
CHING-HOU SU	10/18/2011
CHYI-TSONG NI	10/18/2011
WUN-KAI TSAI	10/24/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
<b>Street Address:</b>	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK
<b>City:</b>	HSINCHU
<b>State/Country:</b>	TAIWAN
<b>Postal Code:</b>	300
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17089183
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	T5057-B502C
<b>NAME OF SUBMITTER:</b>	RANDY A. NORANBROCK
<b>SIGNATURE:</b>	/Randy A. Noranbrock/

PATENT

<b>DATE SIGNED:</b>	11/04/2020
<b>Total Attachments: 2</b> source=EfiledAssign#page1.tif source=EfiledAssign#page2.tif	

Docket No. T5057-B502

## ASSIGNMENT

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned,

- |                  |                  |
|------------------|------------------|
| 1) Yun-Tai SHIH  | 5) Jui-Mu CHO    |
| 2) Kuan-Ming PAN | 6) Ching-Hou SU  |
| 3) Jeng-Hao LIN  | 7) Chyi-Tsong NI |
| 4) I-Shi WANG    | 8) Wun-Kai TSAI  |

who has made a certain new and useful invention, hereby sells, assigns and transfers unto

**TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.** having a place of business at No. **8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu 300, Taiwan R.O.C.**

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

### **BONDING ALIGNMENT TOOL AND METHOD**

(a) for which an application for United States Letters Patent was filed on 2011-10-06, and identified by United States Patent Application No. 13/267,336; or

(b) for which an application for United States Letters Patent was executed on \_\_\_\_\_,

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Yun Tai Shih  
Name: Yun-Tai SHIH

10/18/2011  
Date:

2) Kuan Ming Pan  
Name: Kuan-Ming PAN

10/25/2011  
Date:

3) Jeng-Hao Lin  
Name: Jeng-Hao LIN

10/18/2011  
Date:

4) I Shi Wang  
Name: I-Shi WANG

10/18/2011  
Date:

5) Jui-Mu Cho  
Name: Jui-Mu CHO

10/26/2011  
Date:

6) Ching-Hou Su  
Name: Ching-Hou SU

10/18/2011  
Date:

7) Chyi-Tsong Ni  
Name: Chyi-Tsong NI

10/18/2011  
Date:

8) Wun-Kai Tsai  
Name: Wun-Kai TSAI

10/24/2011  
Date: